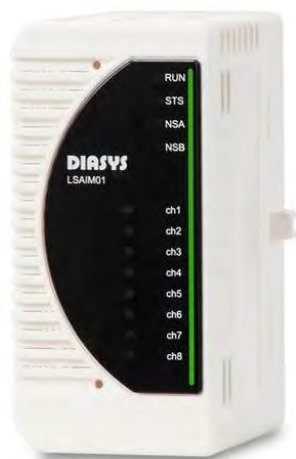


LSAIM01 AI module

LS communication Analog inputs : 8 4 to 20 mA/0 to 20 mA

■ Summary



* Number of inputs	: 8 (Channel individual isolation)
* Input range	: 4 to 20 mA/0 to 20 mA (Selectable)
* Absolute precision	: $\pm 0.1\%$ FS @25°C
* Temperature drift	: ± 100 ppm/°C or less
* Module ambient temperature range	: -5 to 60°C
* Insulation method	: Photocoupler insulation

LSAIM01 AI module

LS communication Analog inputs : 8 4 to 20 mA/0 to 20 mA

■ Specifications

ITEM		SPECIFICATION
Input	Number of channels	8 (Channel individual isolation)
	Range	4 to 20 mA/0 to 20 mA (Selectable for communication setting) (Full Scale)
	Internal impedance	50 Ω or less
	Resolution	16 bits
Absolute precision	@25°C	$\pm 0.1\%$ FS
Temperature drift	@-5 to 60°C	± 100 ppm/°C or less (relative to full-scale)
CMRR		100 dB or more attenuation
NMRR		About 11 dB attenuation (When the first-order lag filter is set to 10 ms or more, attenuation by 20 dB or more)
Data refresh cycle		10 ms /All channels
Input filter		Software digital filter (Channel individual)
Dielectric strength		AC 500 V input terminal – between PE Between input channels
Communication with IOA	Communication method	LVDS
	Communication speed	100 Mbps
Self-diagnostic functions		Power voltage check (24 V, 3.3 V, 1.2 V) Clock check (FPGA-MCU for diagnosis, MCU for diagnosis –FPGA) Heartbeat check (FPGA-MCU for diagnosis, MCU for diagnosis –FPGA) CRC check (FPGA) AI communication error check (ch abnormal)
Detective		ADC abnormal check I/O signal range check (Overrange, Underrange)
When disconnected		Detect underrange
Protection	(Power supply protection)	Overvoltage protection Overcurrent protection
Indicator	Display LED	4: RUN(Run) / STS(Status) / NSA(Network status A) / NSB(Network status B)
Insulation method		Photocoupler insulation
Hot swap		Possible
Power supply		DC 24 V $\pm 20\%$ (The voltage supplied from the backplane)
Environmental conditions	Module ambient temperature	(Operating) -5 to 60°C (Storage) -40 to 85°C
	Module ambient humidity	(Operating / Storage) 10 to 95% RH (No condensation)
Vibration		3.5 mm @5 to 8.4 Hz 1 G @8.4 to 150 Hz
Shock		15 G 11 ms
Rated Current		68 mA
Weight		0.11 kg
Dimensions		62 mm (D) x 94 mm (H) x 46 mm (W) (Except projection)
Standard/Directive		EN 61131-2:2007, RoHS

About compliant module type

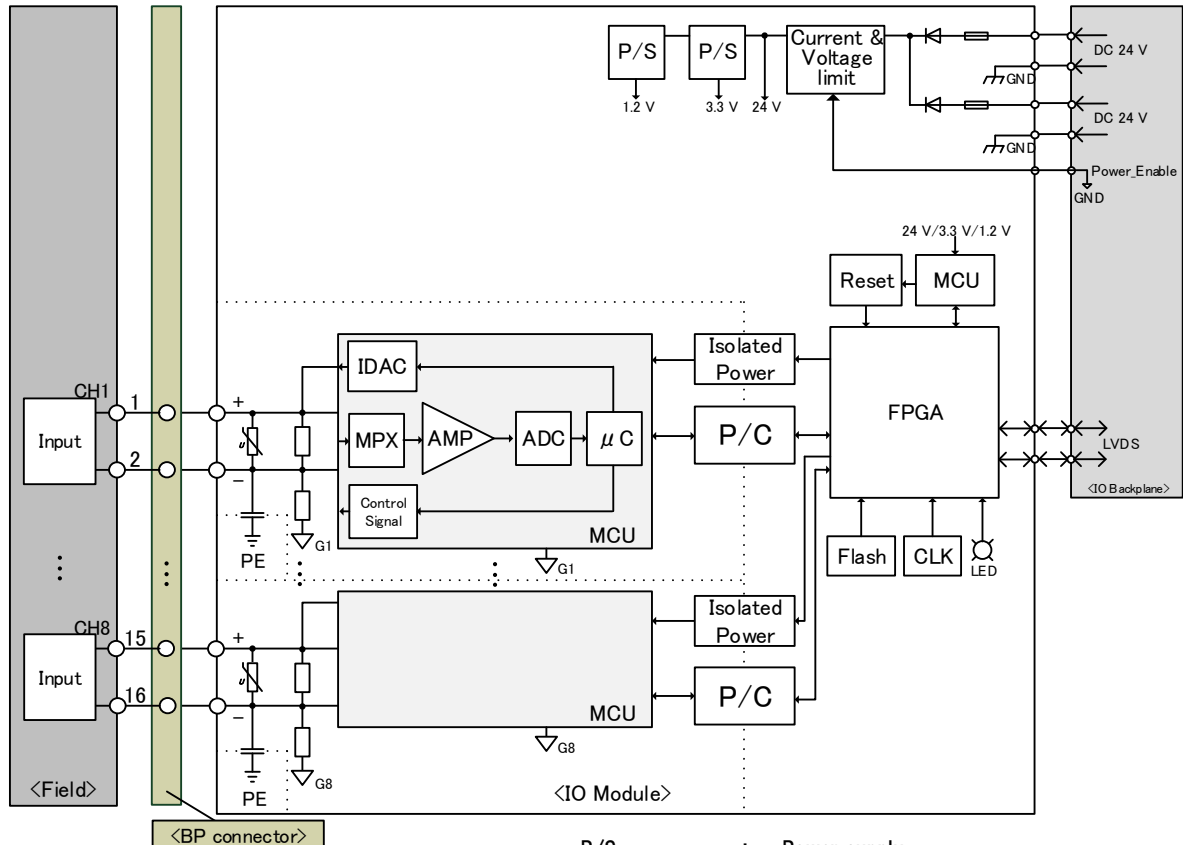
For compliant modules of this product, please refer to “Compliant backplane list (CGS-S9901-E-XX)”.

For compliant modules of this product, please refer to “Compliant accessory connector list (CGS-S9902-E-XX)”.

LSAIM01 AI module

LS communication Analog inputs : 8 4 to 20 mA/0 to 20 mA

■Block diagram



P/S	:	Power supply
IDAC	:	1out Digital analog converter
MPX	:	Multiplexer
AMP	:	Amplifier
ADC	:	Analog digital converter
μ C	:	Micro controller
CLK	:	Clock
FPGA	:	Field programmable gate array
LED	:	Light emitting diode
MCU	:	Micro control unit
GND,G1 to G8	:	Ground
IOA	:	I/O adapter
LVDS	:	Low Voltage Differential Signaling
BP	:	Backplane
PE	:	Protective Earth
P/C	:	Photocoupler
	:	Varistor
	:	Resistor
	:	Fuse
	:	Diode
	:	Capacitor

When using, please read the instruction manual attached to the product carefully and use it properly.

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